

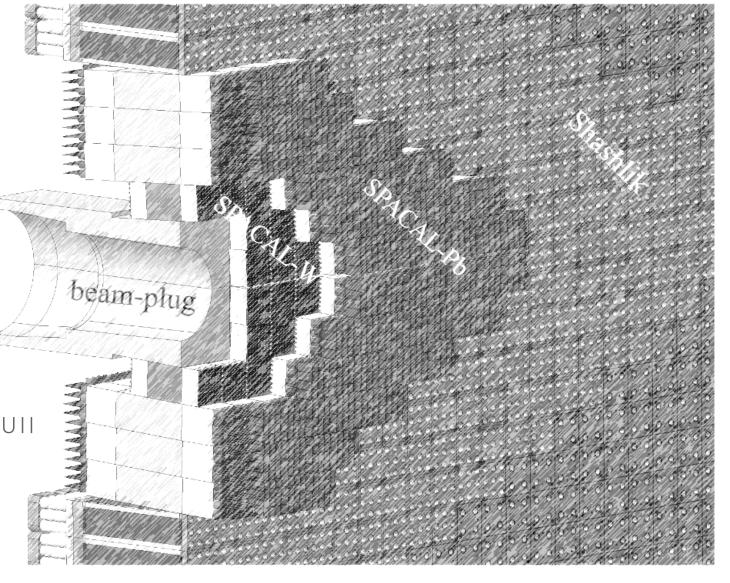


PHOTODETECTORS AND READOUT FOR PICOCAL: R&D OPTIONS AT UMD

Workshop on US contribution to LHCb UII University of Maryland

FRIDAY MARCH 17TH 2023

PHOEBE M HAMILTON (UNIVERSITY OF MARYLAND)



Up-front Caveats

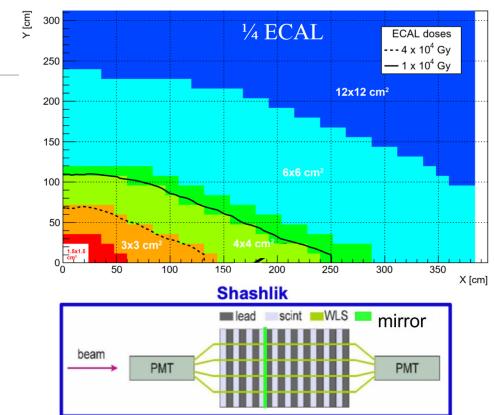
- This is largely an outsider perspective
 - Mostly gathered from zoom meetings and Orsay workshop

 Any misstatements, misunderstandings, or glaring omissions are my own

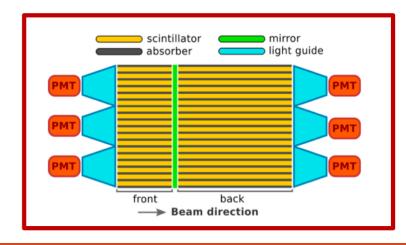
- Goal here: open up thinking on UMD or broader US contributions to photodetectors and their readout
 - If targets and paths were crystal clear we could skip the workshop and go straight to writing

Numerology Reminders

- •6016ch Current -> 30 208 ch U2
 - 32x 64-cell SPACAL-W
 - 144x 16-cell SPACAL-Pb
 - 272x 9-cell Shashlik
 - 896x 4-cell Shashlik
 - 1344x 1-cell Shashlik
- Baseline: double-sided Shashlik readout (right)
 - Downscope: Shashlik single-sided only -> 19 456
- •PMTs:
 - 1 PMT/ch (OR 1 anode/ch?? MaPMT option)
 - Single type ideal
 - Split by SPACAL/Shashlik probably more costly in time/R&D/logistics than would be saved from relaxed spec.....

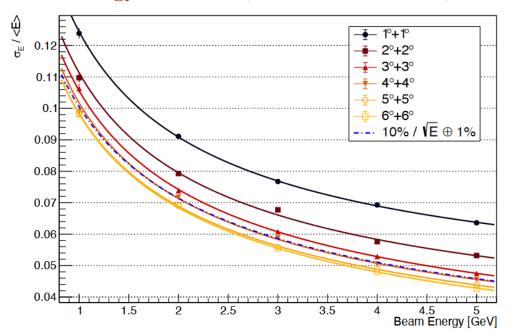




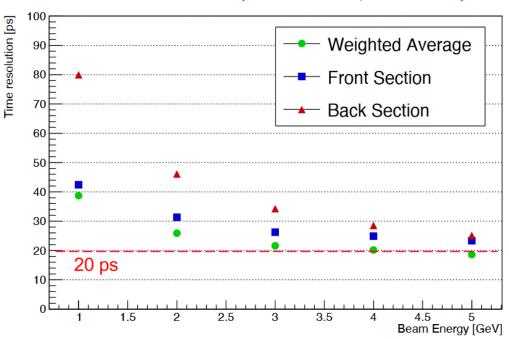


Performance goals

Energy resolution (DESY 2020, R12421)



Time resolution (DESY 2020, R7600-20)



- Maintain $\sigma(E)/E \approx 10\%/\sqrt{E} \oplus 1\%$
- Occupancy mitigation via improved granularity
- $^{\circ}$ Pile-up mitigation via O(10~ps) time precision
- Need photodetectors that keep up with or optimize this performance and satisfy the tough environmental and aging constraints

PMT conditions

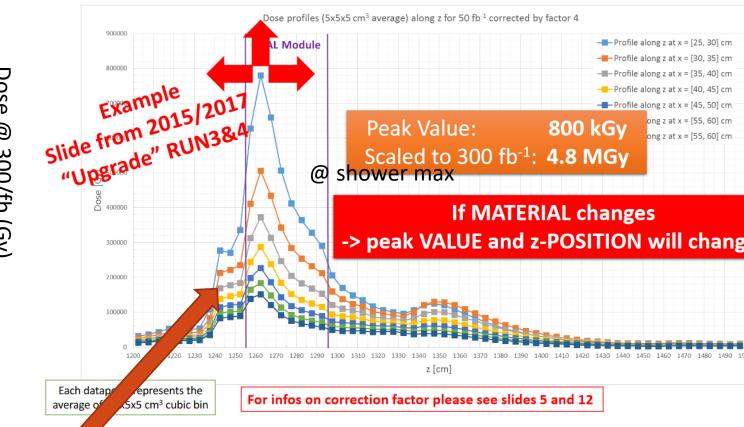
- Upgrade 2
 - Expect ≤ 1 MGy in center
 - 20 000 γ/GeV (undoped GAGG)
 - Hopefully will come down naturally with faster crystals
 - 5 mT B field
 - Shielding needs dependent on TTS
 - Remote HV (stability? noise?)
 - Integrated charge > 10³C/year
 - Emission:
 - 550nm GGAG
 - 450nm PS
 - 500-550nm Sashlik WLS
 - -> Varying decay times, varying light yields, varying (?) intrinsic rise

- •c.f. Run1-2
 - $\circ \approx 1 \text{ kGy/fb}^{-1}$
 - 3000 γ/GeV
 - $^{\circ}$ Calibration follows E_{\max}^T
 - Gain factors $(1-15) \times 10^3$
 - 5 mT B field shielding used
 - Local HV derviation (CW base)
 - Y11 peak at 476 nm
 - \circ Y11 WLS \rightarrow 7ns decay time

Radiation Detail

1.0e+03 10⁵ 1.0e+04 104 100 0 1.0e+05 300/fb (Gy) 10³ 10² -100 -200 -300 -300 200 300 -100100 X [cm]

Dose profiles along z for the upgrade (50 fb⁻¹ at 14 TeV)



Aside: Important region to understand for PMTs on front side, depends sensitively on material model

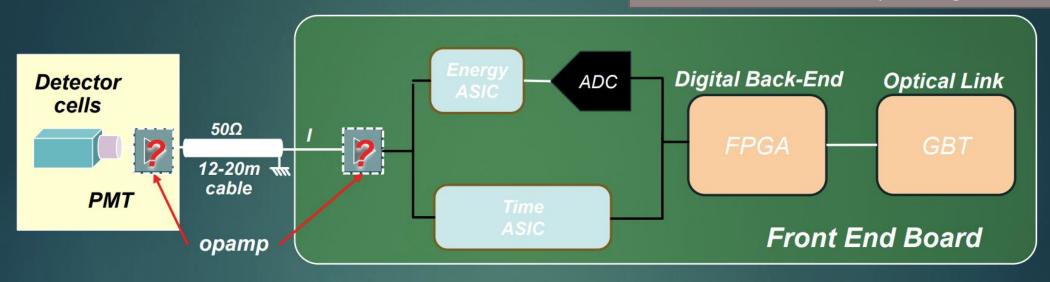
Matthias Karacson @ Orsay wkshp Profile shape in z w/module boundaries

Readout Architecture

QUICK REFRESHER

Chosen architecture

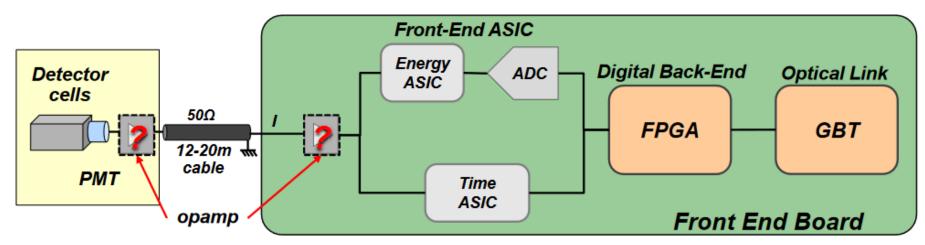
Slide stolen from Christophe Beigbeder-Beau



- > Two separate processing paths with dedicated Asics in the same techno 65 nm:
 - Energy path close to the current ICECAL scheme (mostly analog processing)
 - > Timing path based on a waveform TDC.
 - For dynamic range compatibilities, cable attenuation, Signal range Gain, noise, BW requirements:
 - Amplification and shaping either at the PM level or on the FEB.
 - Opamp stage + dedicated passive attenuator for each ASIC could provide the optimal signal conditioning (see Edu's talk)

PMT Signal Conditioning

- Photodetectors readout solution follows the same scheme as in current ECAL:
 - Minimal light transport with PMT sensors near modules,
 - All electronics in crates on top of the detector (reduced radiation),
 - Connection via analog link (coaxial) ~12m long (up to 20m considered).
- ASIC/chipset in TSMC 65nm with separate energy and timing processing paths

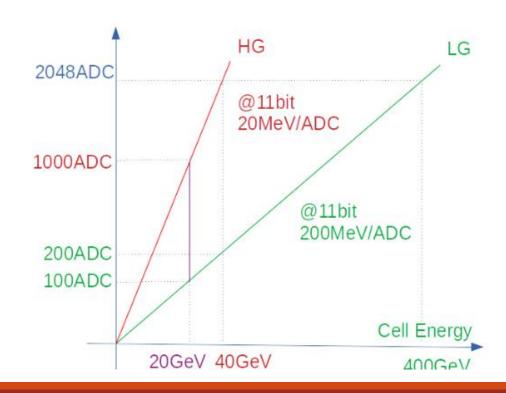


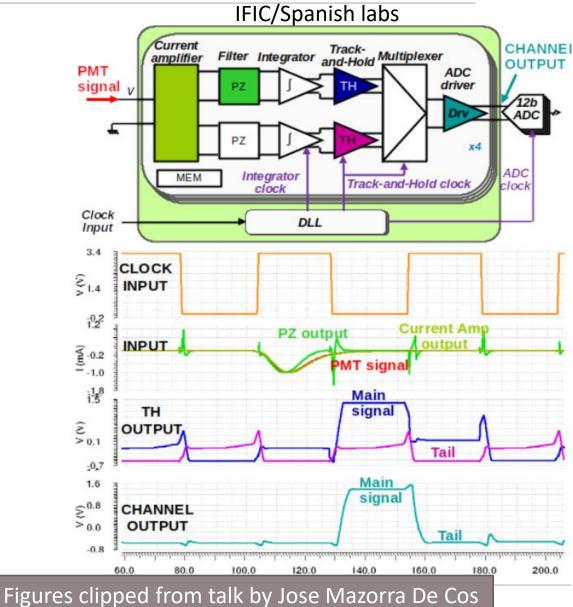
- Amplifier + Shaper circuit included on the PMT base or FEB under consideration
 - To compensate cable attenuation, improve SNR, if necessary, and reduce spill-over effort
 - To act as a buffer to help split the signal between paths
 - Different ASIC requirements (signal range, gain, noise, BW): add dedicated passive attenuator for each path.
 - If at FEB, use differential outputs to ASICs



Energy measurement: ICECAL II

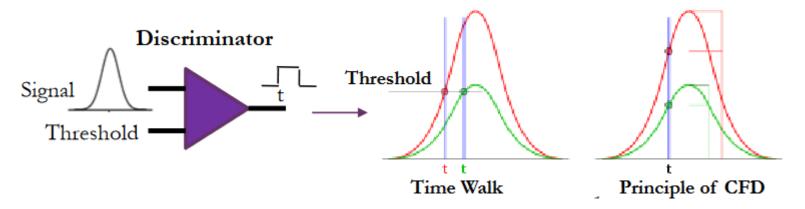
- Dual-gain scheme to allow for larger dynamic range
 - Need to keep one eye on input/conditioning requirements
- •PMT performance: linearity, gain stability, aging, rate effect





Time measurement

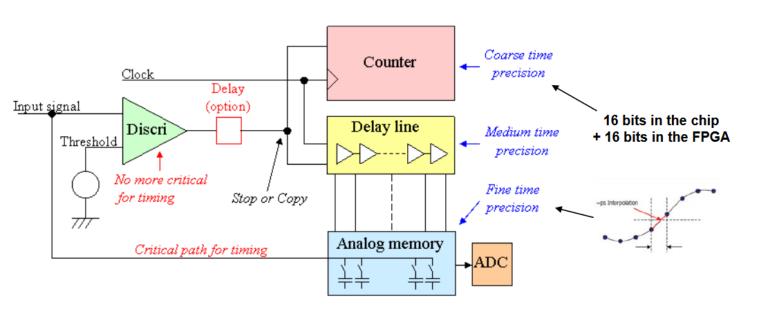
Figures clipped from talks by Philippe Vallerand, Dominic Breton, and Christophe Beigbeder-Beau

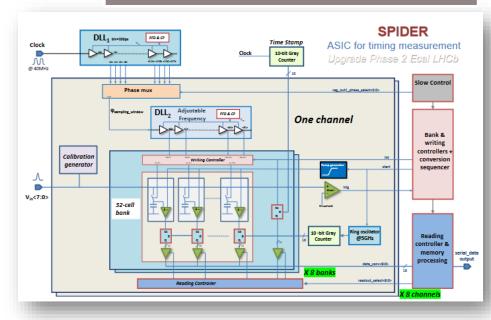


- •Fundamental problem: need to derive timestamps from waveforms very quickly
 - Fastest simple structure, discriminator+TDC, creates time-walk effect X
 - Constant-fraction discrimination is more stable vs amplitude, harder to do in real-time
 - Analog implementation introduces delay lines that degrade performance in front of ASIC
 - Much easier "after the fact" with digitized waveform

Waveform TDC

Figures clipped from talks by Philippe Vallerand, Dominic Breton, and Christophe Beigbeder-Beau





IJCLab + other IN2P3

- Use analog memory to buffer waveform and use constant-threshold discriminator for timing only
 - Pass along waveform for interpolated CFD timing measurement in FPGA
- Looks rather like an oscilloscope timing measurement on-a-chip!

Waveform TDC timing capability

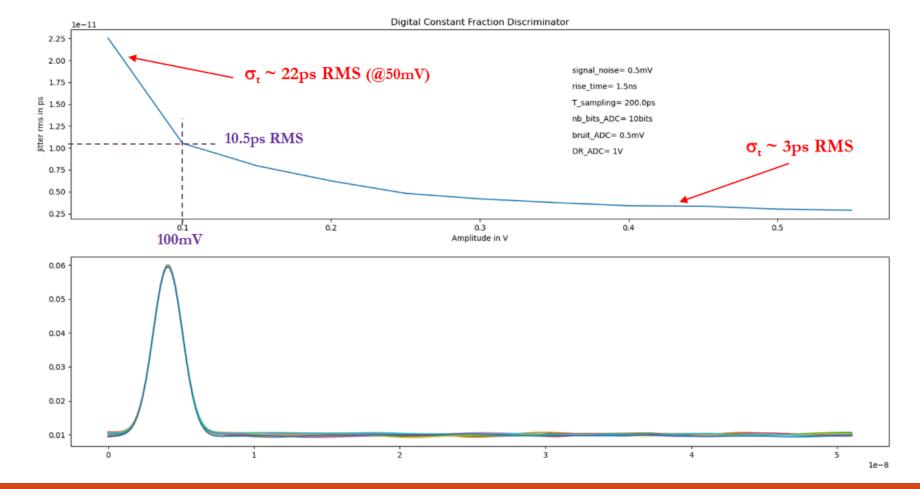
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Timing jitter versus signal amplitude:

rise time = 1.5ns; σ_{noise} = 500 μ VRMS; σ_{SCA} = 500 μ VRMS

- Plot from Dominique @ Orsay workshop
- Timing measurement exceptionally good at high end of dynamic range
 - Low end may be an issue dynamic range may extend below 50mV
 - Compensation options:
 - Lower noise
 - Higher Vmax
 - Faster rise time (jitter ~ noise/slope)
- •PMT performance: TTS, uniformity, rise time

Just to compare, here we use a reduced dynamic range of 20 => Vin ranges from 50mV to 1V

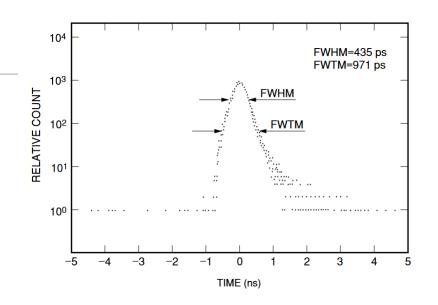


R&D targets

Rise time and TTS

- •TTS represents an intrinsic limitation on time performance, need to understand and optimize
 - Possible trade-off against other desirable features, e.g. magnetic field tolerance vs TTS for fine-mesh

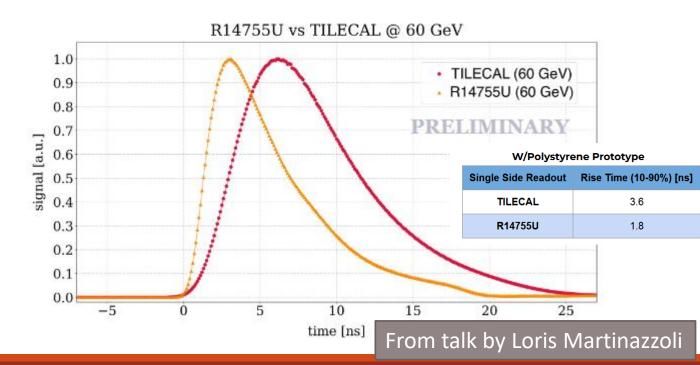
- •Fast rise time may help with time resolution at lower energies
 - What is intrinsic limit of the modules?
 - What is the trade-off with TTS?



Hammamatsu

THBV3 0419EA

Figure 4-19: TTS (transit time spread)

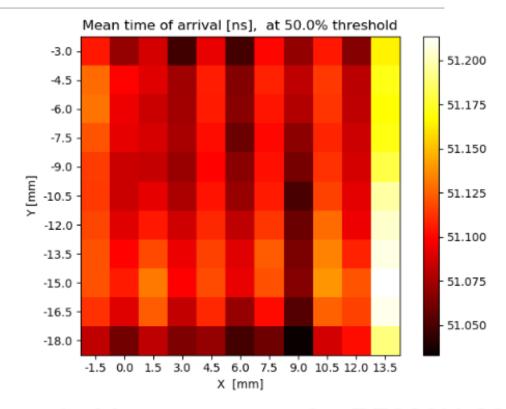


Time response uniformity

•Spread due to different timing for signal build up starting at different positions on photocathode

- Needs to be understood well for each candidate model
 - Possible to mitigate/minimize with mfg cooperation?
 - Part of QA characterization?
 - Possible to reduce with lightguide?

 Option to use MaPMT brings in a similar uniformity discussion, but now between-cell uniformity!



Example Measurements for R7600U-20 total σ_t = 41 ps

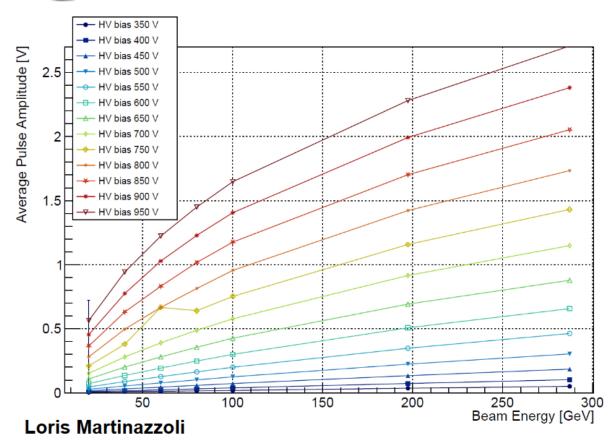
E. Picatoste, ECAL U2 R&D Meeting 2 March

Linearity

- Currently some non-optimal behavior from round PMT candidates
 - Would like to understand how to reproduce and investigate on bench so mitigation strategies can be validated without relying on test beam time



Round PMT amplitudes Vs. HV Vs. E

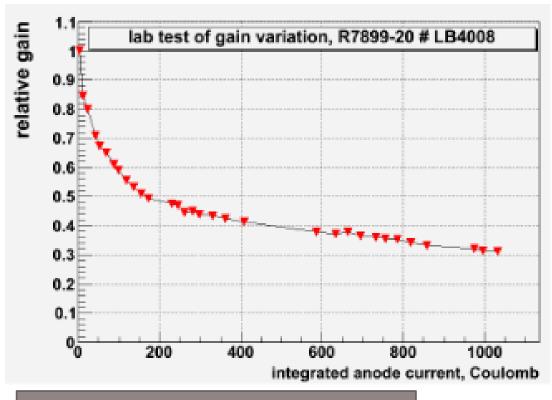


17 P.M. HAMILTON 17 March 2023

Aging

•Even if reduced light yield GAGG is chosen, still many system-level decisions influenced by aging behavior

 Crucial to study behavior out to end-of-life (+irradiated?)



Studies for original ECAL

Dug up from old meetings by Iouri Guz

Optimization with MFG

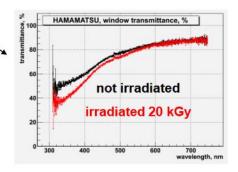
- •Expect that optimal PMT solution will require iteration with manufacturers
 - UMD involvement can allow for parallel testing, crossvalidation of results, faster convergence on solutions

R7899-20

Main modification wrt the original R7899:

- spherical photocathode → flat (HAMAMATSU UV glass)
 - reduces price
 - · improves radiation tolerance (thin)
 - · but increases transit time spread
- · photocathode: made green-extended
 - improved QE for Y11 light
 - from HCAL beam tests of 2003, the photoelectron yield was 60/GeV with Photonis XP3102 and 100/GeV for HAMAMATSU R7899-20
- · reduced rate effect
 - probably via special treatment of dynode holders

Intermediate R7899-11



Example: PMTs for Run1/2 ECAL (Iouri Guz @ 2 March R&D MTG)

2023-02-03

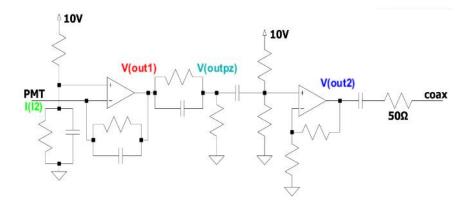
From talk by Iouri Guz

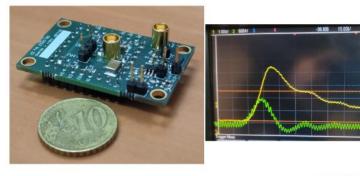
Conditioning Electronics

 UMD electronics experience opens possibilities for contributions to signal conditioning circuit R&D, in addition to characterization

PMT signal Conditioning: Opamp Circuit

- · Two stage OpAmp based circuit on PMT divider:
 - Transimpedance amplifier(OPA847) boost SNR.
 - PZ cancellation network reduce pulse width.
 - High slew rate coaxial cable driver(OPA695).
- Radiation damage limits available commercial components:
 - design dedicated ASIC or integrate in front-end board.
- · Board designed and produced, now under test.
 - Stability is not completely fixed





3 February 2023

LHCb ECAL Upgrade II R&D

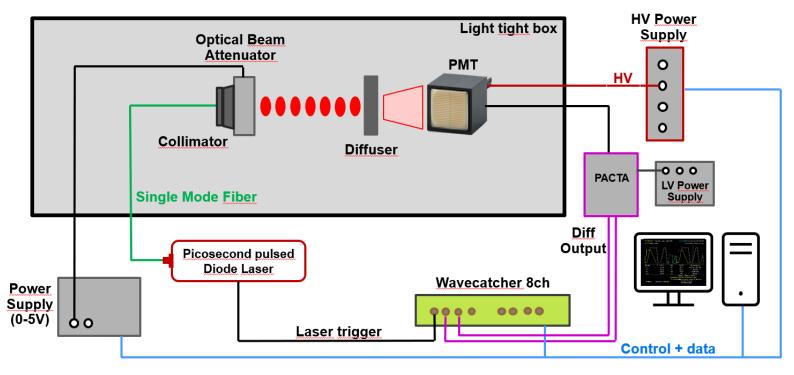
SICCUB

Slide from Eduardo Picatoste

UMD lab ideas

Lab needs

- Starting point: similar setup to Barcelona group
- Will need to source laser, light box, optical table, collimator, diffuser, other optics
- Acquisition and digitization, power, control likely doable with materials on-hand
- •TBD: what additional/unique capability do we want to try to build out from there?



9 March 2023



Figure from Eduardo Picatoste

Lab costs

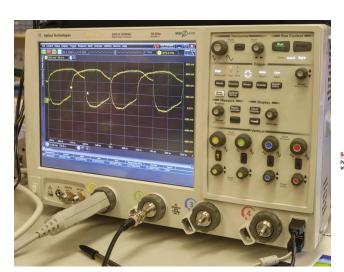
Item	Approx Cost (kUSD)
Laser	22
Laser shutter	1.5
Optical table top	9-10
Optical table support	1-2
HV Supply	4.5
Light box frame	0.5
Light box breadboard	0.2
Misc through-wall connectors	?
Opto & mech hardware	<~1?
Total	~42

On hand:

- LV supplies (various)
- 16 GHz / 40 GSa scope
 - Differential mid- and high-bandwidth active probes
 - Automated acquisition and signal processing needed

Very possible using PC control up to modest rep rates

Excellent student project





Summary

- Possible R&D path at Maryland involves characterization and development of PMT
 - Potentially very sensitive to many different parameters of performance and robustness
 - Hope to work at UMD on optimization of the PMTs in close collaboration with readout design

•Interesting possibilities to interface with colleagues at Barcelona and CERN, potentially culminating in development of custom solutions with industry